

Xencor™ PA66 LCF-2030

polyamide 66

Xencor™ PA66 LCF-2030, a 30% long carbon fiber reinforced, heat stabilized PA66, can easily be processed on most injection molding machines.

The material exhibits an excellent combination of high stiffness and impact performances, while ensuring ease of processing and fast cycle times. It provides high strength, outstanding stiffness

retention at high temperature, excellent creep and fatigue resistance, isotropic mechanical properties with low isotropic shrinkage, and excellent surface finish.

Available in natural, the pellet length is 7mm.

Natural: Xencor™ PA66 LCF-2030 BK001-7

General

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Material Status	 Commercial: Active 				
Availability	• Europe				
Filler / Reinforcement	 Long Carbon Fiber, 30% 	0% Filler by Weight			
Features	Creep ResistantFatigue ResistantHigh Stiffness	High StrengthLow ShrinkageOutstanding Surface Finish			
RoHS Compliance	 RoHS Compliant 				
Appearance	 Natural Color 				
Forms	 Pellets 				
Processing Method	Compression MoldingInjection Molding	Overmolding			
Physical		Typical Value	Unit	Test method	
Density		1.28	g/cm³	ISO 1183	
Molding Shrinkage - Flow		0.25	%	ISO 294-4	
Water Absorption (Equilibrium, 23°C, 50% RH)		1.7	%	ISO 62	
Mechanical		Typical Value	Unit	Test method	
Tensile Modulus (23°C)		24000	MPa	ISO 527-1	
Tensile Stress (Yield, 23°C)		325	MPa	ISO 527-2	
Tensile Strain (Break, 23°C)		2.0	%	ISO 527-2	
Flexural Modulus (23°C)		22500	МРа	ISO 178	
Flexural Stress (23°C)		435	МРа	ISO 178	
Impact		Typical Value	Unit	Test method	
Charpy Notched Impact Strength (23°C)		18	kJ/m²	ISO 179	
Charpy Unnotched Impact	55	kJ/m²	ISO 179		

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Thermal	Typical Value Unit	Test method
Deflection Temperature Under Load		
0.45 MPa, Unannealed	255 °C	ISO 75-2/B
1.8 MPa, Unannealed	250 °C	ISO 75-2/A
CLTE - Flow (23°C)	1.8E-5 cm/cm/°C	ISO 7991
Thermal Conductivity	0.51 W/m/K	ISO 22007
Electrical	Typical Value Unit	Test method
Surface Resistivity	1.0E+2 ohms	ASTM D257
Injection	Typical Value Unit	
Drying Temperature	110 °C	
Drying Time	4.0 hr	
Suggested Max Regrind	15 %	
Rear Temperature	270 to 300 °C	
Middle Temperature	270 to 300 °C	
Front Temperature	285 to 310 °C	
Nozzle Temperature	285 to 320 °C	
Processing (Melt) Temp	< 310 °C	
Mold Temperature	80 to 160 °C	

Injection Notes

Pre-Drying

• Since polyamides are hygroscopic materials as well as sensitive to moisture during processing, this product should always be pre-dried. At a humidity content above 0.1%, the material will begin to degrade. Recommended drying time is 4 hours at 110°C in dry-air dryer.

Mold Temperature

• The mold temperature is a compromise between the optimum properties that can be obtained from high crystallization, and cycle time. This product can be processed at mold temperatures between 80°C and 160°C. Optimum surface quality requires a mold temperature above 100°C.

Regrind

• This product should only be recycled with special care. The regrind content must never exceed 15%, and only regrind of optimum quality should be used. In any case, part properties should be checked.

Notes

Typical properties: these are not to be construed as specifications.

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